

Product data sheet

1. General description

AC Thyristor Triac power switch in a SOT78 (TO-220AB) plastic package with selfprotective clamping capabilities against low and high energy transients.

2. Features and benefits

- Clamping structure ensuring safe high over-voltage withstand capability
- Full cycle AC conduction
- Over-voltage withstand capability to IEC 61000-4-5
- Pin compatible with standard triacs
- Planar passivated for voltage ruggedness and reliability
- Protective self turn-on capability for high energy transients
- Safe clamping capability for low energy over-voltage transients
- Less sensitive gate for high noise immunity
- Triggering in three quadrants only
- Very high immunity to false turn-on by dV/dt

3. Applications

- AC fan, pump and compressor controls
- Highly inductive, resistive and safety loads
- Large and small appliances (White Goods)
- Reversing induction motor controls

4. Quick reference data

| | ick reference data | • · · · · · | | _ | | |
|---------------------|--|--|-----|-----|-----|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| V _{DRM} | repetitive peak off- state voltage | | - | - | 800 | V |
| I _{TSM} | non-repetitive peak on- state current | full sine wave; T _{j(init)} = 25 °C; t _p = 20 ms; <u>Fig. 4; Fig. 5</u> | - | - | 120 | A |
| Tj | junction temperature | | - | - | 125 | °C |
| I _{T(RMS)} | RMS on-state current | full sine wave; T _{mb} ≤ 95 °C; <u>Fig. 1;</u> <u>Fig. 2; Fig. 3</u> | - | - | 12 | A |
| V _{PP} | peak pulse voltage | T _j = 25 °C; non-repetitive, off-state; Fig. <u>6</u> | - | - | 2 | kV |





AC Thyristor Triac power switch

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------------|---------------------------------------|--|------|-----|-----|------|
| Static chara | acteristics | · · · · · · | I | | | |
| I _{GT} | gate trigger current | V _D = 12 V; I _T = 100 mA; LD+ G+; T _j = 25 °C; <u>Fig. 8</u> | - | - | 35 | mA |
| | | V _D = 12 V; I _T = 100 mA; LD+ G-; T _j = 25 °C; <u>Fig. 8</u> | - | - | 35 | mA |
| | | V _D = 12 V; I _T = 100 mA; LD- G-; T _j = 25 °C; <u>Fig. 8</u> | - | - | 35 | mA |
| V _{CL} | clamping voltage | I_{CL} = 0.1 mA; t _p = 1 ms; T _j = 25 °C | 850 | - | - | V |
| Dynamic cl | haracteristics | · · · · | I | 1 | | |
| dV _D /dt | rate of rise of off-state voltage | V_{DM} = 536 V; T _j = 125 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit | 3000 | - | - | V/µs |
| dl _{com} /dt | rate of change of commutating current | $\label{eq:VD} \begin{split} V_D &= 400 \text{ V}; \text{T}_{j} = 125 ^\circ\text{C}; \text{I}_{\text{T}(\text{RMS})} = 12 \text{ A}; \\ dV_{\text{com}}/dt &= 20 \text{V}/\mu\text{s}; \text{(snubberless} \\ \text{condition}); \text{gate open circuit} \end{split}$ | 14 | - | - | A/ms |

5. Pinning information

| Table 2. | Pinning | information | | |
|----------|---------|---------------------|--------------------|----------------|
| Pin | Symbol | Description | Simplified outline | Graphic symbol |
| 1 | СМ | common | mb | LD |
| 2 | LD | load | | _G |
| 3 | G | gate | | СМ |
| mb | LD | mounting base; load | | 003aaf296 |
| | | | | |
| | | | | |
| | | | | |
| | | | 1 2 3 | |
| | | | TO-220AB (SOT78) | |

6. Ordering information

| Table 3. Ordering information | | | | | | |
|-------------------------------|----------|--|---------|--|--|--|
| Type number | Package | | | | | |
| | Name | Description | Version | | | |
| ACTT12-800C | TO-220AB | plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB | SOT78 | | | |

7. Marking

| Table 4. Marking codes | |
|------------------------|--------------|
| Type number | Marking code |
| ACTT12-800C | ACTT12-800C |

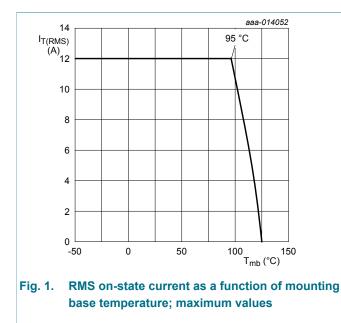
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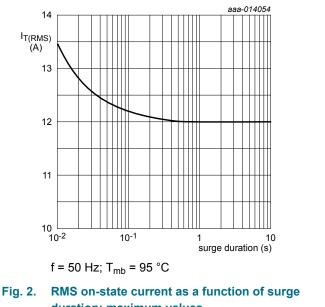
8. Limiting values

Table 5.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

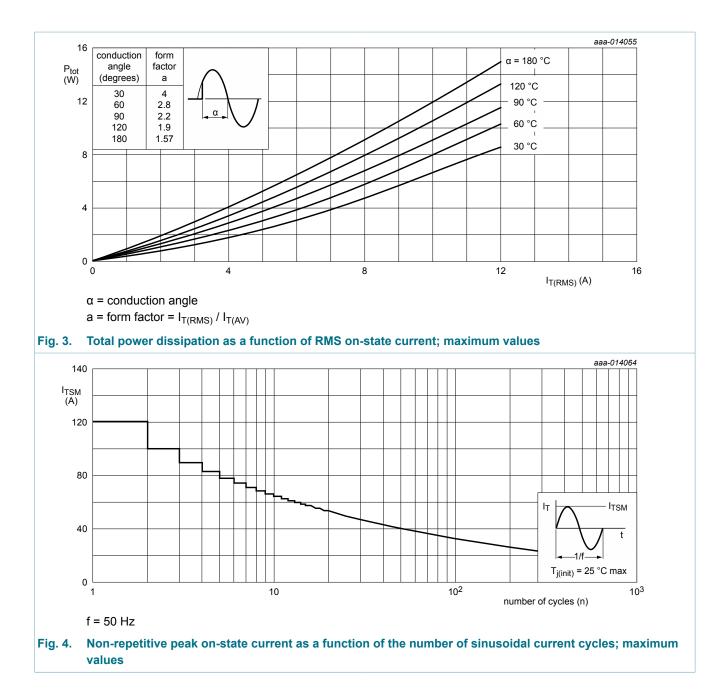
| Symbol | Parameter | Conditions | Min | Max | Unit |
|---------------------|--------------------------------------|--|-----|-----|------------------|
| V _{DRM} | repetitive peak off-state voltage | | - | 800 | V |
| I _{T(RMS)} | RMS on-state current | full sine wave; T _{mb} ≤ 95 °C; <u>Fig. 1;</u> <u>Fig. 2; Fig. 3</u> | - | 12 | А |
| I _{TSM} | non-repetitive peak on-state current | full sine wave; T _{j(init)} = 25 °C; t _p = 20 ms; <u>Fig. 4; Fig. 5</u> | - | 120 | A |
| | | full sine wave; $T_{j(init)}$ = 25 °C; t_p = 16.7 ms | - | 132 | A |
| l ² t | I ² t for fusing | t _p = 10 ms; sine-wave pulse | - | 72 | A ² s |
| dl _T /dt | rate of rise of on-state current | I_T = 12 A; I_G = 0.2 A; dI_G/dt = 0.2 A/µs | - | 100 | A/µs |
| I _{GM} | peak gate current | t = 20 μs | - | 2 | А |
| P _{GM} | peak gate power | | - | 5 | W |
| P _{G(AV)} | average gate power | over any 20 ms period | - | 0.5 | W |
| T _{stg} | storage temperature | | -40 | 150 | °C |
| Tj | junction temperature | | - | 125 | °C |
| V _{PP} | peak pulse voltage | T _j = 25 °C; non-repetitive, off-state; Fig. <u>6</u> | - | 2 | kV |





duration; maximum values

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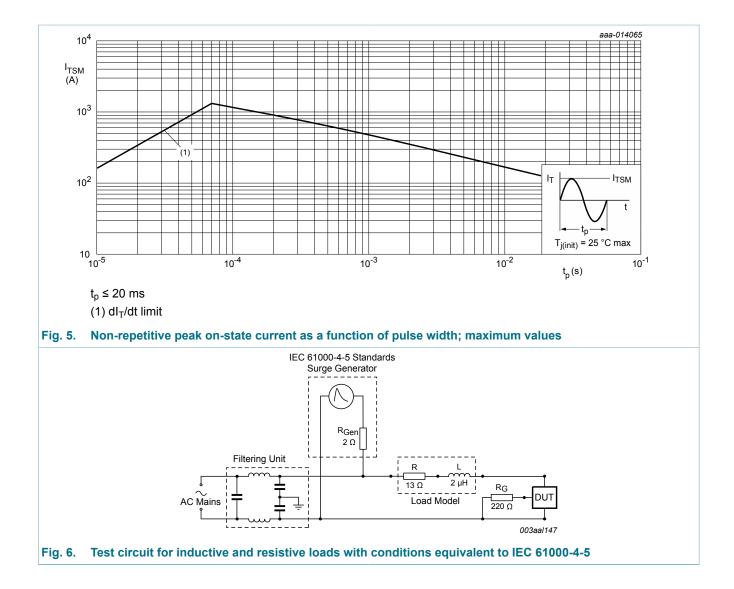
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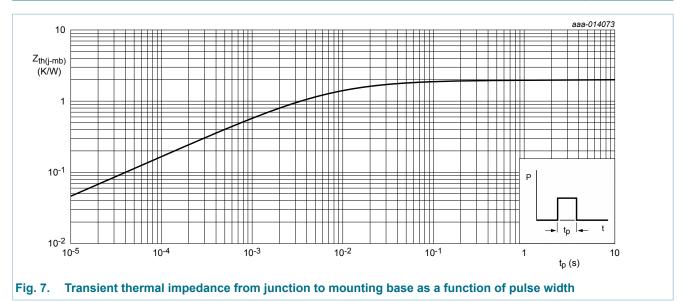
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9. Thermal characteristics

| Table 6. 1 | Thermal characteristics | | | | | |
|-----------------------|---|---------------------------|-----|-----|-----|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| R _{th(j-mb)} | thermal resistance from junction to mounting base | full cycle; <u>Fig. 7</u> | - | - | 2 | K/W |
| R _{th(j-a)} | thermal resistance from junction to ambient | in free air | - | 60 | - | K/W |



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10. Characteristics

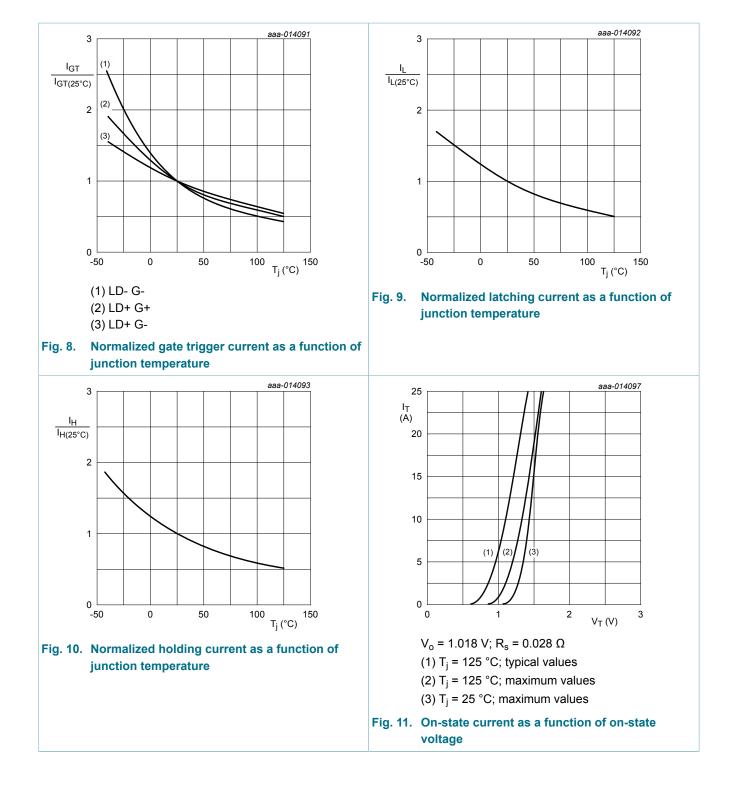
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------------|---------------------------------------|--|------|------|-----|------|
| Static chara | acteristics | · · · · · · | | | | |
| I _{GT} | gate trigger current | $V_D = 12 \text{ V}; \text{ I}_T = 100 \text{ mA}; \text{ LD+ G+};$ $T_j = 25 \text{ °C}; \text{ Fig. 8}$ | - | - | 35 | mA |
| | | V _D = 12 V; I _T = 100 mA; LD+ G-; T _j = 25 °C; <u>Fig. 8</u> | - | - | 35 | mA |
| | | V _D = 12 V; I _T = 100 mA; LD- G-; T _j = 25 °C; <u>Fig. 8</u> | - | - | 35 | mA |
| l | latching current | V _D = 12 V; I _G = 100 mA; LD+ G+; T _j = 25 °C; <u>Fig. 9</u> | - | - | 50 | mA |
| | | V _D = 12 V; I _G = 100 mA; LD+ G-; T _j = 25 °C; <u>Fig. 9</u> | - | - | 70 | mA |
| | | V _D = 12 V; I _G = 100 mA; LD- G-; T _j = 25 °C; <u>Fig. 9</u> | - | - | 50 | mA |
| I _H | holding current | V _D = 12 V; T _j = 25 °C; <u>Fig. 10</u> | - | - | 50 | mA |
| V _T | on-state voltage | I _T = 17 A; T _j = 25 °C; <u>Fig. 11</u> | - | 1.25 | 1.5 | V |
| V _{GT} | gate trigger voltage | V _D = 12 V; I _T = 100 mA; T _j = 25 °C; Fig. 12 | - | 0.8 | 1 | V |
| | | V _D = 400 V; I _T = 100 mA; T _j = 125 °C; Fig. 12 | 0.2 | 0.45 | - | V |
| I _D | off-state current | V _D = 800 V; T _j = 25 °C | - | - | 10 | μA |
| | | V _D = 800 V; T _j = 125 °C | - | - | 0.5 | mA |
| V _{CL} | clamping voltage | I _{CL} = 0.1 mA; t _p = 1 ms; T _j = 25 °C | 850 | - | - | V |
| Dynamic cl | naracteristics | | I | | | |
| dV _D /dt | rate of rise of off-state voltage | V_{DM} = 536 V; T _j = 125 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit | 3000 | - | - | V/µs |
| dl _{com} /dt | rate of change of commutating current | V_D = 400 V; T_j = 125 °C; $I_{T(RMS)}$ = 12 A; dV _{com} /dt = 20 V/µs; (snubberless condition); gate open circuit | 14 | - | - | A/ms |

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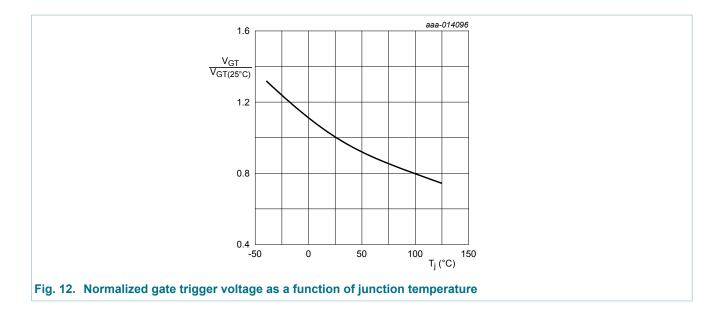
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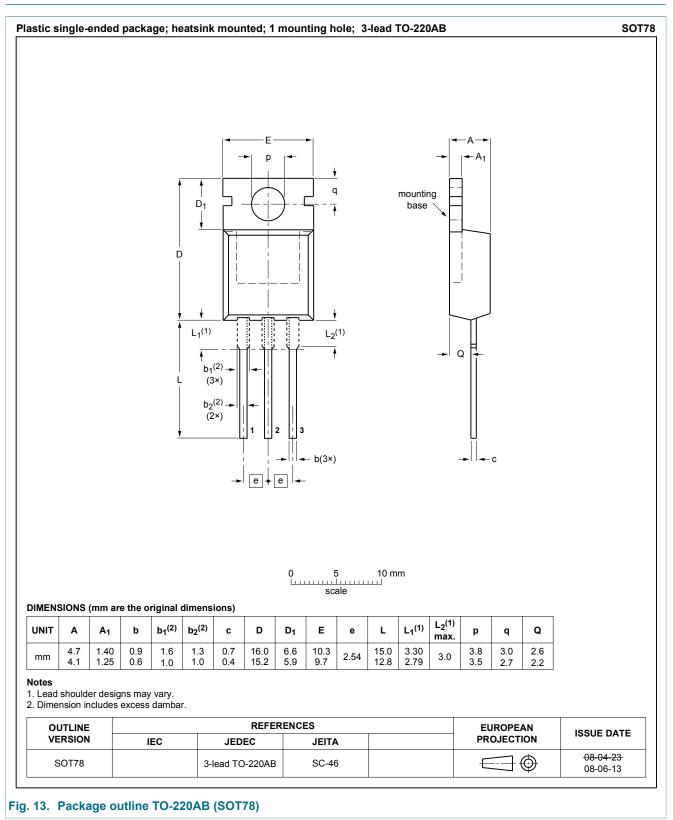


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11. Package outline



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|--------------------------------------|-----------------------|---|
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AC Thyristor Triac power switch

13. Contents

| 1 | General description | 1 |
|------|-------------------------|----|
| 2 | Features and benefits | 1 |
| 3 | Applications | 1 |
| 4 | Quick reference data | 1 |
| 5 | Pinning information | 2 |
| 6 | Ordering information | 2 |
| 7 | Marking | 3 |
| 8 | Limiting values | 4 |
| 9 | Thermal characteristics | 7 |
| 10 | Characteristics | 8 |
| 11 | Package outline | 11 |
| 12 | Legal information | 12 |
| 12.1 | Data sheet status | 12 |
| 12.2 | Definitions | 12 |
| 12.3 | Disclaimers | 12 |
| 12.4 | Trademarks | 13 |
| | | |

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